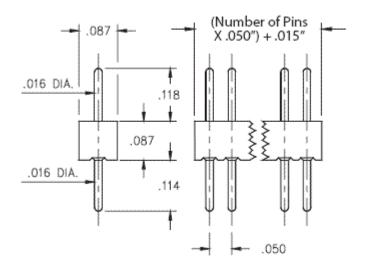


# **DATA SHEET**

Product Number: 850-40-003-10-001000



## **Description:**

Interconnect Header .050 Grid; Straight Pin Header Single Row Through Hole

**Plating Code:** 

40

**Shell Plating:** 

200  $\mu^{\text{\tiny{"}}}$  Tin (matte finish) over 100  $\mu^{\text{\tiny{"}}}$  Nickel

#	Mill-Max	RoHS
Of	Part	Compliant
Pins	Number	

3 850-40-003-10-001000



#### **LOOSE PIN:**

Loose Pin Used: 4006

BRASS ALLOY (UNS C36000) per ASTM B 16

## **Properties of BRASS ALLOY:**

• Chemical composition: Cu 61.5%, Zn 35.4%, Pb 3.1%†

• Hardness as machined: 80-90 Rockwell B

• Density: .307 lbs/in3

Electrical conductivity: 26% IACS\*

• Melting point: 900°C/885°C (liquidus/solidus)

†(3 to 4% lead is used to permit "free machining" and is permitted by EC Directive 2002/95Annex 6; so all pin materials are RoHS compliant)

\*International Annealed Copper Standard, i.e. as a % of pure copper.

## **INSULATOR INFORMATION:**

PCT Polyester, (Thermx CG933, black)

High Temperature

## **Properties of PCT Polyester:**

• Brand: Thermx

• Grade: CG-933

• Rated voltage: 100 VRMS/150 VDC

• Insulation resistance: 10,000 Megaohms min.

• Material Heat Deflection Temp (per ASTM D 648): 529°F (276°C) @ 66 psi

• Dielectric strength: 1000 VRMS min. (700 VRMS min. for series 117 Shrink DIP)

Note: Materials above 446°F (230°C) are considered suitable for "eutectic" reflow soldering, above  $500^{\circ}$ F (260°C) for "lead-free" reflow soldering.